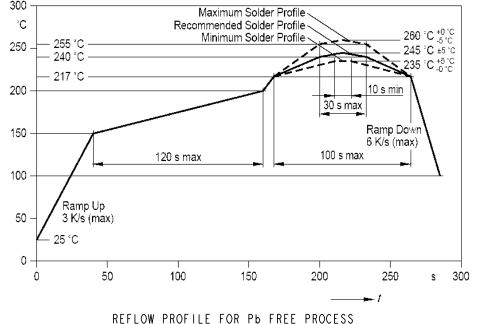
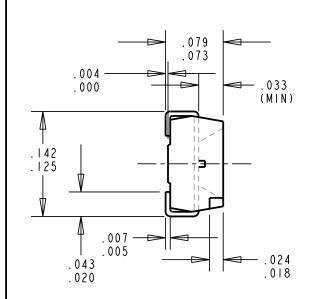
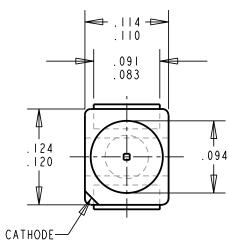
,C		Recomme	imum Solder P ended Solder P	rofile	26	:0 :0 +0 °C
	5 °C ———	IVIII	imum Solder P	rofile	20	30 °C +0 °C -5 °C 15 °C ±5 °C
	0°C			30 s ma	10 s min	35 °C +5 °C
150		120 s max		100 s ma	Ramp Dov 6 K/s (max	yn (
100	/	TEO O THEX	<u></u>		<del>     </del>	
50 - F 3	Ramp Up K/s (max)					
0 - 23	50	100	150	200	250	s 30







OPERATING	CHARACTE	ERISTICS	AT 25°C	AMBIEN	NT
CHARACTERISTICS	MIN	TYP	MAX	UNITS	TEST CONDITIONS
LUMINOUS INTENSITY	11.2	19.6	28.0	mc d	I F = 10 mA
FORWARD VOLTAGE		2.0	2.5	٧	I F = 10 mA
REVERSE CURRENT		. 0 I	10.0	μА	Vr = 12 V
PEAK WAVELENGTH		572		nm	Ir = 10 mA
DOMINANT WAVELENGTH	564	570	576	nm	I F = 10 mA
VIEWING ANGLE (2 0 1/2)		120		DEG.	

ABSOLUTE MAXIMUM RATING AT 25°C	AMBIENT	UNITS
POWER CONSUMPTION	95	mW
REVERSE VOLTAGE	12	V
DERATE LINEARLY FROM 60 °C	. 75	mA/°C
CONTINUOUS FORWARD CURRENT	30	mA
SOLDERING TEMPERATURE FOR 10 SEC.	260	°C
OPERATING TEMPERATURE	-40 TO 100	°C
STORAGE TEMPERATURE	-40 TO 100	°C

## — . I 75 – . 095

RECOMMENDED SOLDER PAD LAYOUT

## NOTES:

- I. EPOXY COLOR: WATER CLEAR.
- 2. DIE: GaAsP/GaP GREEN LED.
- 3. LEADS: TIN (Sn) OVER NICKEL (Ni)
- 4. SOLDER ADHERANCE: BOTH LEADS PER MIL-STD-202E, METHOD 208C.
- 5. SUFFIX -202F FOR 20-PCS ON A SAMPLE TAPE STRIP.

REV | ECN NO

**REVISIONS** 

NEW RELEASE

DRN CKD APP

TWC

DATE

- 6. SUFFIX -207F FOR 180 mm DIA. REEL, 8 mm WIDE TAPE, PACKAGED 2000 PCS PER REEL WITH A PITCH OF 4 mm.
- 7. DEVICES POSITIONED ON REEL WITH CATHODE SIDE TOWARDS SPROCKET.
- 8. DIALIGHT P/N:597-3301-202F, 597-3301-207F.
- 9. TAPE AND REEL LEDS MAY REQUIRE RE-TAPING AFTER TWELVE MONTHS.
- 10. DEVICES HAVE A MOISTURE SENSITIVITY LEVEL OF "2" CAUTION LABEL APPLIED AS PER JEDEC STD. 033.
- II. THIS PRODUCT IS ROHS COMPLIANT (Pb FREE). EACH BAG AND REEL IS MARKED WITH ROHS COMPLIANT LABEL 9100-117-0852-99 OR EQUIVALENT MARKING.

